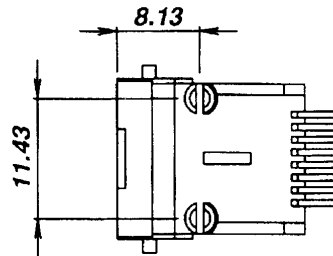


PCB LAYOUT



SPECIFICATION :

1. Electrical Char.

- Insulation Resistance : 500M-Ohm Min.
- Contact Resistance : 20milli-Ohm Max.
- Rating Current : 1.5A Max.
- Rating Voltage : 120V AC
- Dielectric Voltage : 1,000 Vrms 60 Sec. Min.

2. Physical char.

- Housing : Nylon 46 (UL 94V-0)
- Color : Black Color
- Spring Wire : 0.35mm Thickness Phosphor Bronze
- Gold Plating Over Nickel
- Temperature Range : - 25 /+90 Deg C
- Durability : 500 Mating cycles Min.

HC-031SH 8SMD F X

F=8p8c

Gold plated	1=15u , 3=50u 2=30u , 4= 6 u
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TITLE

**RJ45 Very Low Profile PCB Jack
UL & cUL FILE NO. E131820**

**MODULAR JACKS ASSY FOR
HC-031SH-8SMD-F-X**

SCALE SIZE DWG. NO. 9631S-8SMD SERIES

NOT SCALED DRAWING	TOLERANCE UNLESS OTHERWISE NOTICE	INCH	MM	DR.	DATE
 THIRD ANGLE PROJECTION	LINEAR $\frac{MM}{INCH}$	00±0.1	00±0.25	CK'D	MAR-31 '03
		000±0.05	000±0.13	Johnn	MAR-31 '03
	ANGLE +0°30'	RADIL	+0.45 -0.15	APP'D	
				Billy	MAR-31 '03

DWG. NO.
AS031021